

FORM PTO-1594
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U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 05453.0023

To the Honorable Commissioner of Patents and
Please record the attached original documents or copy thereof.

100752976

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):

Kazuhiko KITA, Koji SAITO, Koju TACHI,
Teruaki ONOGI and Kenji HIGASHI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance

☒ Assignment

Merger

☐ Security Agreement

☐

Change of Name

Other

☐

Execution Date: May 1, 1998

2. Name and address of receiving party(ies):

Name: YKK CORPORATION

Internal Address:

Street Address: No. 1, Kanda Izumi-cho, Chiyoda-ku,
Tokyo, Japan

City:

State:

Zip Code:

Additional name(s) & Address(es) attached?

☐ Yes ☒ No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s):

09/025,778

B. Patent Number(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington

State: DC Zip: 20005-3315

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

☒

Enclosed (Please charge deficiency to deposit account)

☐

Authorized to be charged to deposit account

8. Deposit account number: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Arthur S. Garrett

June 12, 1998

Signature

Date

06/29/1998 JMWTKINS 00000140 09025778

01 FC:581

Total number of pages including cover sheet, attachments and documents: 3

PATENT

REEL: 9268 FRAME: 0609

A S S I G N M E N T

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled: HIGH-STRENGTH, HIGH-DUCTILITY ALUMINUM ALLOY

for which I/WE executed an application for United States Letters Patent concurrently herewith or on _____ or filed an application for United States Letters Patent on February 19, 1998 (Serial No. 09/025,778); and

WHEREAS, (1) YKK CORPORATION, a corporation of Japan, whose post office address is (1) No.1, Kanda Izumi-cho, Chiyoda-ku, Tokyo, Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. Full Name of Sole or First Assignor	: Assignor's Signature	: Date
<u>Kazuhiko KITA</u>	: <u>Kazuhiko Kita</u>	: <u>May 1, 1998</u>
Address <u>3-18-8, Yagiyamaminami, Taihaku-ku, Sendai-shi, Miyagi,</u>	: Citizenship	
<u>Japan</u>	: <u>Japan</u>	
2. Full Name of Second Assignor	: Assignor's Signature	: Date
<u>Koji SAITO</u>	: <u>Koji SAITO</u>	: <u>May 1, 1998</u>
Address <u>1-24, Shiwa-cho, Wakabayashi-ku, Sendai-shi, Miyagi, Japan</u>	: Citizenship	
	: <u>Japan</u>	
3. Full Name of Third Assignor	: Assignor's Signature	: Date
<u>Koju TACHI</u>	: <u>Koju Tachi</u>	: <u>May 1, 1998</u>
Address <u>1-28-5, Tenjinzawa, Izumi-ku, Sendai-shi, Miyagi, Japan</u>	: Citizenship	
	: <u>Japan</u>	

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P. · WASHINGTON, D.C.

4. Full Name of Fourth Assignor	: Assignor's Signature	: Date
<u>Teruaki ONOGI</u>	: <u>Teruaki ONOGI</u>	: <u>May 1, 1998</u>
Address <u>1-15-22-201, Tomigaoka, Tomiya-cho, Kurokawa-gun,</u>		: Citizenship
<u>Miyagi, Japan</u>		: Japan
5. Full Name of Fifth Assignor	: Assignor's Signature	: Date
<u>Kenji HIGASHI</u>	: <u>Kenji HIGASHI</u>	: <u>May 1, 1998</u>
Address <u>3-4-9, Teraikedai, Tondabayashi-shi, Osaka, Japan</u>		: Citizenship
		: Japan
6. Full Name of Sixth Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
7. Full Name of Seventh Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
8. Full Name of Eighth Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
9. Full Name of Ninth Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
10. Full Name of Tenth Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
11. Full Name of Eleventh Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		:
12. Full Name of Twelfth Assignor	: Assignor's Signature	: Date
	:	:
Address		: Citizenship
		: